CoreSDR_AXI v2.0

Handbook

Microsemi

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Introduction

Overview

CoreSDR_AXI is intended to provide a 64-bit advanced microcontroller bus architecture (AMBA®) advanced extensible interface (AXI) to an external single data rate (SDR) synchronous dynamic random access memory (SDRAM). The design consists of an AXI controller, read and write data buffers, and a single instantiation of CoreSDR, which contains a generic CPU interface. For more information on CoreSDR, refer to the *CoreSDR Handbook*.

Figure 1 shows a high-level block diagram of the CoreSDR_AXI design.

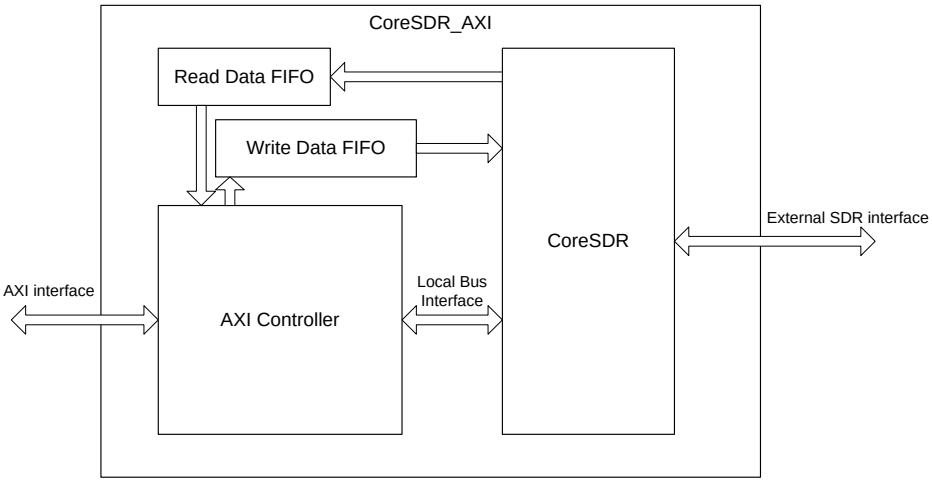

Figure 1 CoreSDR_AXI Block Diagram

Key Features

- High performance, SDR controller for standard SDRAM chips and dual in-line memory (DIMMs)
- Accesses the AXI slave interface through the SmartFusion®2 REVFIC64 fabric interface
- Supports 8,16, and 32-bit memory
- Supports up to 1,024 MB of memory
- Bank management logic monitors status of up to 8 SDRAM banks
- Fully synchronous, buffered register interface

Core Version

This handbook refers to version 2.0 of CoreSDR_AXI.

Supported Families

- SmartFusion®2

Reference Documentation

- *AMBA AXI Protocol Specification*
- *CoreSDR v4.0 Handbook*

Interface

Parameters / Generics

Table 1 outlines the parameters for CORESDR_AXI.

Table 1 ·The Parameters for CoreSDR_AXI

Parameter	Default	Valid Values	Description
Core Parameters			
SDRAM_CHIPS	1	1 to 8	Number of chip selects
SDRAM_COLBITS	8	8 to 12	Number of SDRAM column bits
SDRAM_ROWBITS	11	11 to 14	Number of SDRAM row bits
SDRAM_CHIPBITS	3	1 to 3	Number of encoded chip select bits
SDRAM_BANKSTAT MODULES	4	4, 8	Number of bank status modules
DQ_SIZE	32	8,16,32,64	Width of the SDRAM data bus (DQ). This determines the byte mapping of AXI to SDR. Need elaboration here, but this is more of a Phase1 process.
FAMILY	19	19	SmartFusion2
Timing Parameters			
RAS	6	1-10	SDRAM active to precharge timing, specified in clock cycles
RCD	3	2-5	SDRAM active to read or write delay, specified in clock cycles
RRD	2	2-3	SDRAM active bank *a* to active bank *b*, specified in clock cycles
RP	3	1-4	SDRAM precharge command period, specified in clock cycles
RC	8	3-12	SDRAM active to active/auto-refresh command period, specified in clock cycles
RFC	9	2-14	Auto-refresh to active/auto-refresh command period, specified in clock cycles
MRD	2	1-7	SDRAM load mode register command to active or refresh command, specified in clock cycles
CL	2	1-4	SDRAM CAS latency, specified in clock cycles
WR	2	1-3	SDRAM write recovery time

Ports

Table 2 shows all top-level ports for CORESDR_AXI.

Table 2 ·Top-Level Ports for CORESDR_AXI

Port	Width	Direction	Description
AXI Slave Interface			
ACLK	1	In	Global clock signal
ARESETN	1	In	Global reset (active low)
Write Address Channel			
AWADDR[31:0]	32	In	Write address—Gives the address of the first transfer in a write burst transaction. The associated control signals are used to determine the addresses of the remaining transfers in the burst.
AWLEN[3:0]	4	In	Burst length—Gives the exact number of transfers in a burst. This information determines the number of data transfers associated with the address. Burst sizes of 1, 4, and 8 are supported.
AWSIZE[1:0]	2	In	Burst size—Indicates the size of each transfer in the burst. Byte lane strobes indicate exactly which byte lanes to update. 11: 64-bit (double word) transaction (only 64-bit supported)
AWBURST[1:0]	2	In	Burst type. Only two burst types are supported: 01: INCR 10: WRAP Refer to the *AMBA AXI Protocol Specification* for more information on these types.
AWVALID	1	In	Write address valid—Indicates the valid write address and control information are available.
AWREADY	1	Out	Write address ready— Indicates that the slave is ready to accept an address and associated control signals.
Write Data Channel			
WDATA[63:0]	64	In	Write data
WSTRB[7:0]	8	In	Write strobes— Indicates which byte lanes to update in memory. There is one write strobe for each eight bits of the write data bus. WSTRB[n] corresponds to WDATA [(8 × n) + 7 :(8 × n)]. Since AWSIZE is fixed at 11 (64-bit mode), this is fixed at 8 bits wide (64 / 8 = 8)
WLAST	1	In	Write last— Indicates the last transfer in a write burst.

Port	Width	Direction	Description
WVALID	1	In	Write valid— Indicates that valid write data and strobes are available, 1: Write data and strobes available 0: Write data and strobes not available
WREADY	1	Out	Write ready— Indicates that the slave can accept the write data: 1: Slave ready 0: Slave not ready
Write Response Channel			
BRESP	1	Out	Write response— Indicates the status of the write transaction. The allowable responses are 0: OKAY 1: SLVERR
BVALID	1	Out	Write response valid— Indicates that a valid write response is available: 1: Write response available. 0: Write response not available.
BREADY	1	In	Response ready— Indicates that the master can accept the response information. 1: Master ready 0: Master not ready
Read Address Channel			
ARADDR[31:0]	32	In	Read address— Gives the initial address of a read burst transaction. Only the start address of the burst is provided.
ARLEN[3:0]	4	In	Burst length— Gives the exact number of transfers in a burst. This information determines the number of data transfers associated with the address.
ARSIZE[1:0]	2	In	Burst size— Indicates the size of each transfer in the burst. b00: 8-bit (byte) transaction b01: 16-bit (half word) transaction b10: 32-bit (word) transaction b11:= 64 bit(double word) transaction *Note: Only double word is supported.*
ARBURST[1:0]	2	In	Burst type— Coupled with the size information, details how the address for each transfer within the burst is calculated.
ARVALID	1	In	Read address valid— Indicates, when High, that the read address and control information is valid 1: Address and control valid 0: Address and control not valid

Port	Width	Direction	Description
ARREADY	1	Out	Read address ready. This signal indicates that the slave is ready to accept an address and associated control signals: 1: Slave ready 0: Slave not ready
Read Data Channel			
RDATA[63:0]	64	Out	Read data
RRESP	1	Out	Read response. This signal indicates the status of the read transfer. The allowable responses: 0: OKAY 1: SLVERR
RLAST	1	Out	Read last. This signal indicates the last transfer in a read burst.
RVALID	1	Out	Read valid. This signal indicates that the required read data is available and the read transfer can complete: 1: Read data available 0: Read data not available
RREADY	1	In	Read ready. This signal indicates that the master can accept the read data and response information: 1: Master ready 0: Master not ready
SDR SDRAM Interface			
SDRCLK	1	Out	SDRAM clock – Pass-through AXI clock (no division)
SA[13:0]	14	Out	Address bus
BA[1:0]	2	Out	Bank address
CS_N[7:0]	8	Out	Chip selects
CKE	1	Out	Clock enable
RAS_N	1	Out	Row address strobe
CAS_N	1	Out	Column address strobe
WE_N	1	Out	Write enable
DQM[7:0]	8	Out	Data mask, byte lane strobes (from WSTRB above) determine exactly which bytes are being updated. 8 is the maximum width for this signal. Actual width is determined by DQ/8. That is, each byte has its own strobe. For the case of 64-bit DQ_SIZE, DQM is 8 bits wide.
OE	1	Out	Output enable, tristate control for DQ data bus
DQ[DQ_SIZE-1:0]	DQ_SIZE	Inout	Data bus

Note: The Lock, Cache, and Protect features of AXI are not implemented in CoreSDR_AXI.

Operation

Handshaking

AXI uses a READY/VALID handshake. This means that either the master (from the AHB2AXI bridge through the REVFIC) or the slave (CORESDR_AXI) can delay a transfer. The implication here is that if data is being read out of CoreSDR, it needs to be stored somewhere, since the local bus interface does not have a handshaking process. For more information on this, refer to the Overview section on page 5.

Figure 2 shows the AXI handshaking protocol.

When both VALID and READY are asserted, the data is considered as transferred. This applies for both writes (master controls VALID and slave controls READY) and reads (master controls VALID and slave control READY).

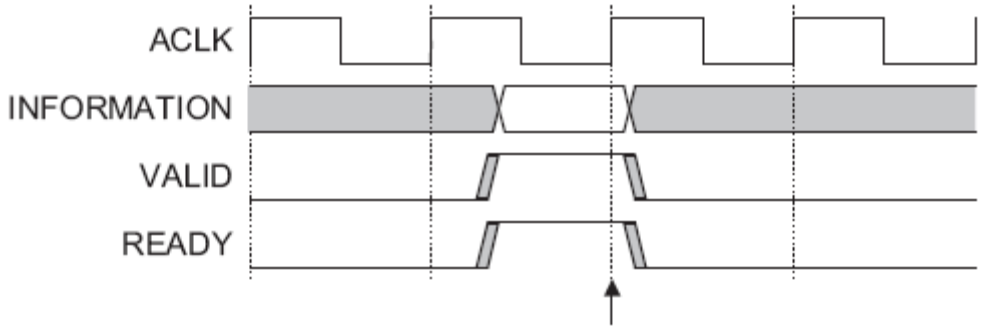

Figure 2 ·AXI READY with VALID handshake

The implication of handshaking is that the master can hold off a read transaction by indicating that it is not ready to receive the data by holding the RREADY AXI signal Low. The master can also delay a write operation by bringing the WVALID signal Low.

This behavior is applied to all the read and write data and address channels. For more information, refer to the *AMBA AXI Protocol Specification.*

Timing Diagrams

CoreSDR Local Bus Interface Timing

The following timing diagrams are extracted from the *CoreSDR Handbook*. For more information on CoreSDR local bus interface timing, refer to the *CoreSDR Handbook*.

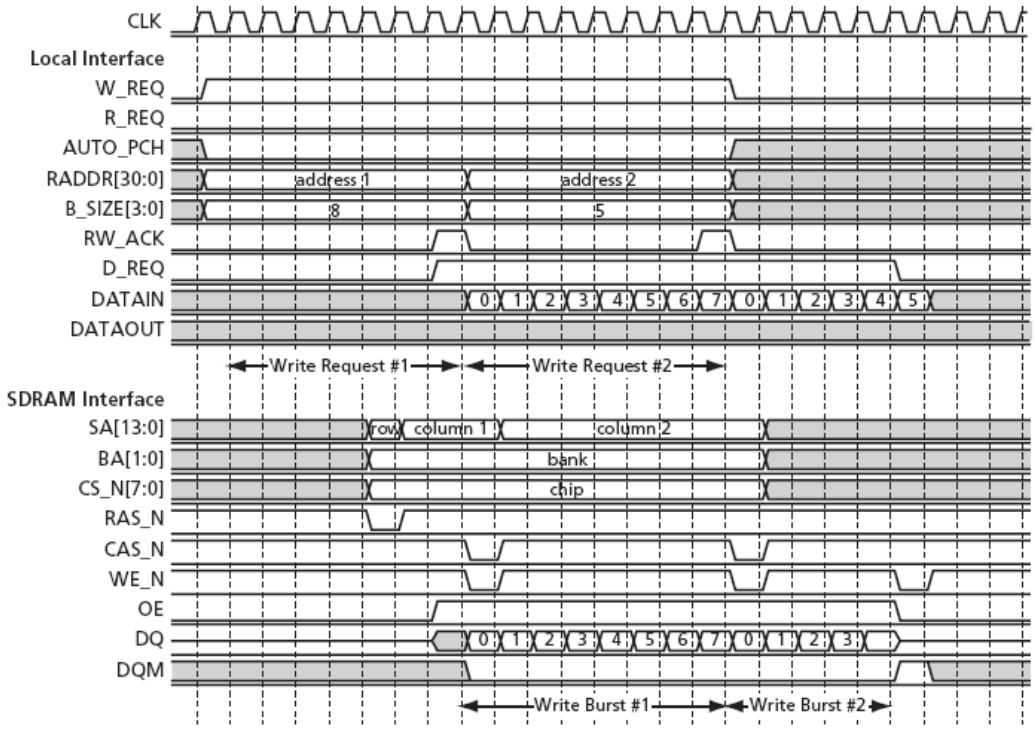

Figure 3 ·CoreSDR Burst Write

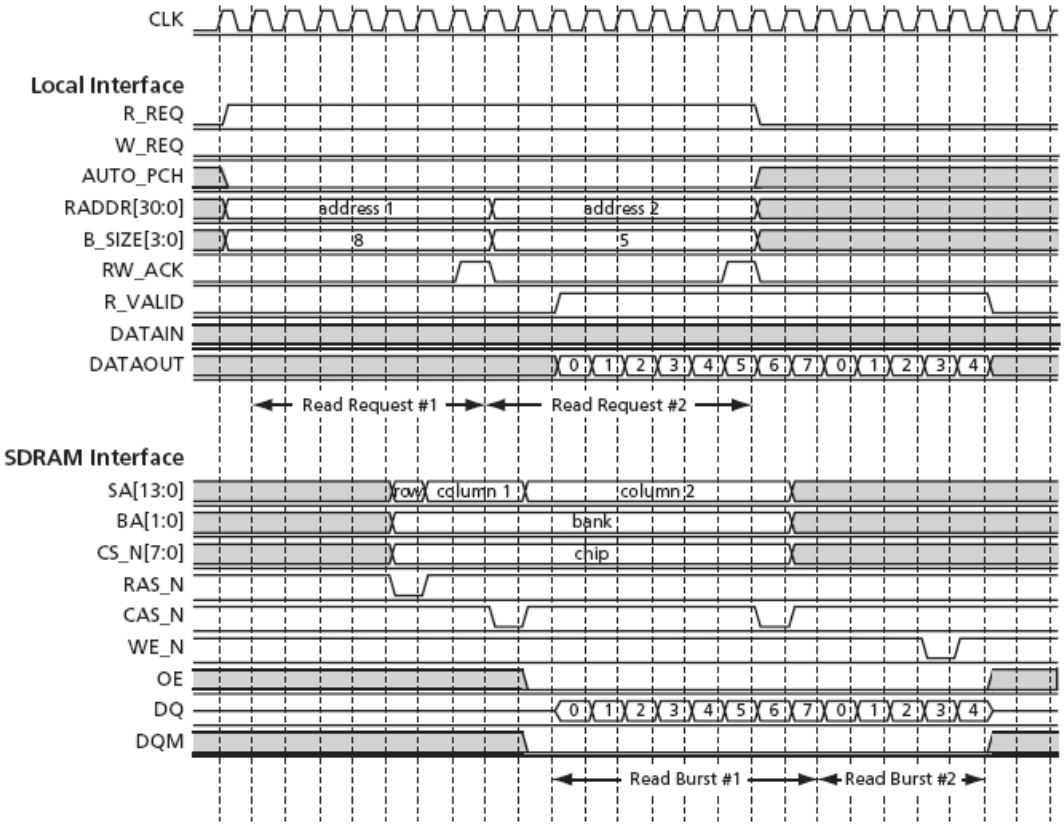

Figure 4 ·CoreSDR Burst Read

Figure 5 is a timing diagram for a read operation, showing the AXI slave interface signals and the corresponding CoreSDR local bus interface signals.

Figure 5 does not show the use of the AXI slave/master VALID/READY handshake. It also does not show all the AXI (or CoreSDR local bus interface) control signals. For each of these, refer to *AMBA AXI Protocol Specification* and *CoreSDR v4.0 Handbook*

Notice the extra clock period of latency of RDATA between the local bus interface and the AXI interface. This is to account for the FIFO between the CoreSDR RDATA[31:0] and the AXI RDATA[63:0].

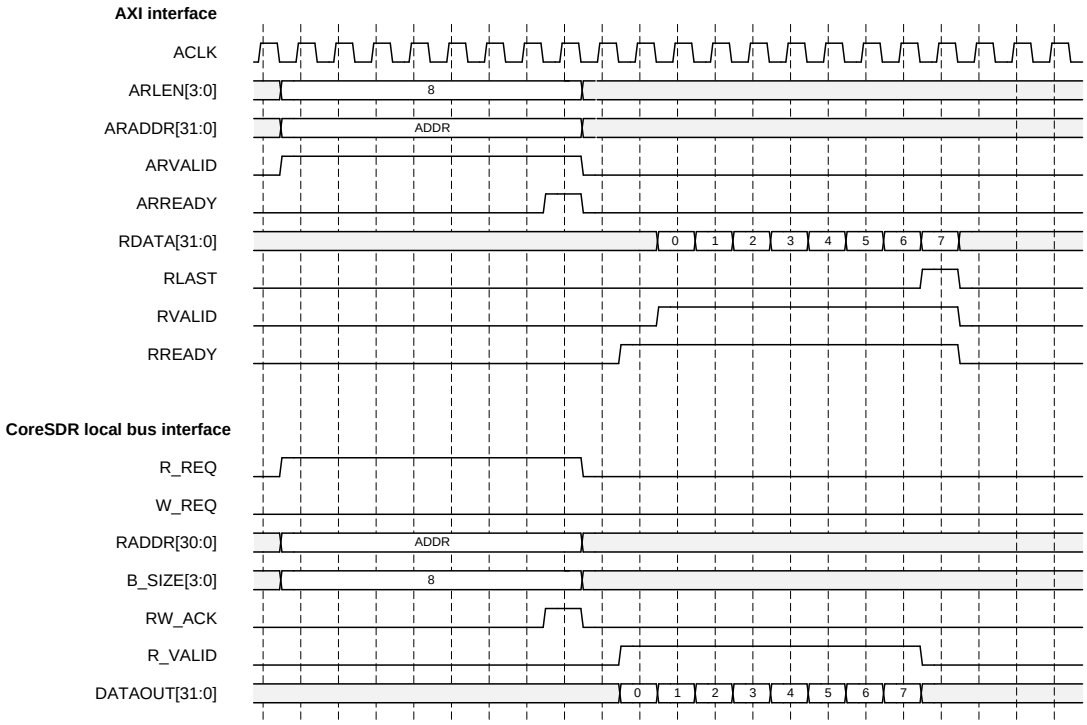

Figure 5 ·Single Burst Read Operation (with no Read operation handshaking)

When the AXI master holds off the data read, the transaction becomes slightly more complicated, as shown in Figure 6.

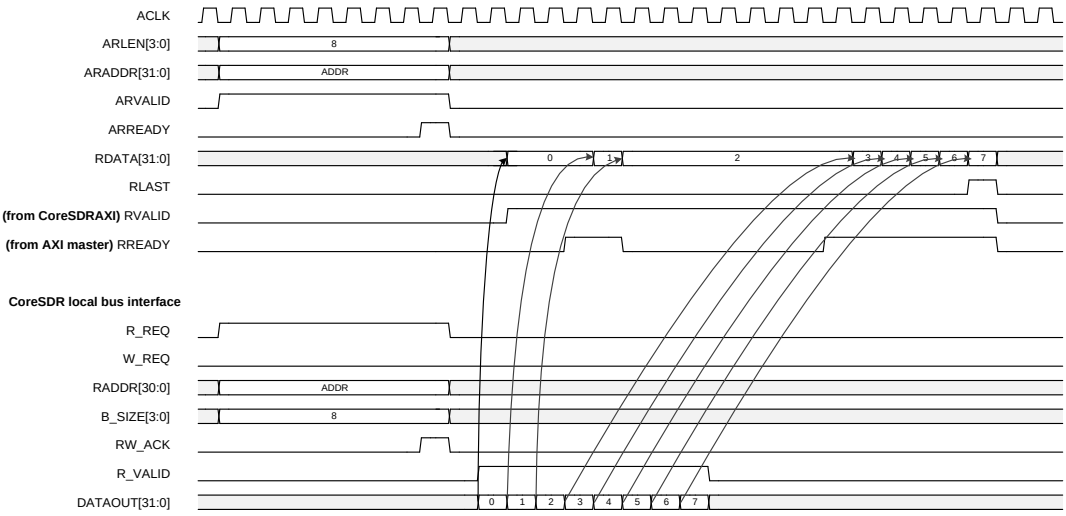

Figure 6 Single Burst Read Operation (with Read operation handshaking)

After the first word of data is transmitted back to the AXI master, the master deasserts the RREADY signals, which indicates to the slave that it is not ready to receive subsequent data. The slave then holds the current data until the RREADY signal is asserted again. The DATAOUT bus, however, which is located on the CoreSDR local bus interface, continues to push out data, as long as the R_VALID signal (incidentally, tied to the AXI RVALID signal) is asserted. This means that a buffer is required on the CoreSDR_AXI side to buffer from the SDRAM.

Write operations are similar, except the slave has the ability to hold off transfers by deasserting the WREADY signal.

Tool Flows

Licensing

CoreSDR_AXI requires a register transfer level (RTL) license to be used and instantiated in unobfuscated (RTL) mode. Complete source code and a testbench are provided for the core in this release. To generate an obfuscated RTL, a license is not required, and an unobfuscated testbench is still provided in this release.

SmartDesign

CoreSDR_AXI is available for download to the Libero® System-on-Chip (SoC) IP Catalog through the web repository. Once it is listed on the catalog, the core can be instantiated using the SmartDesign flow. The core can be configured using the configuration GUI within SmartDesign.

For information on using SmartDesign to instantiate and generate cores, refer to the *Using DirectCore in Libero SoC User's Guide*.

Simulation Flows

The User Testbench for CoreSDR_AXI is included in the release.

To run simulations, select the **User Testbench** flow within SmartDesign and click **Save &** Generate on the Generate pane. The User Testbench is selected through the Core Configuration GUI.

When SmartDesign generates the Libero SoC project, it installs the User Testbench files.

User Testbench

The User Testbench provides examples of how to use CoreSDR_AXI with a memory model, which is provided. The testbench can be modified to suit the requirements.

The testbench consists of an AXI master model, the design under test (CoreSDR_AXI), and a model for a 16-bit mobile SDR memory device.

Synthesis in Libero SoC

Having set the design route appropriately, click **Synthesis** in Libero SoC. The Synthesis window appears, displaying the Synplicity® project. Set Synplicity to use the Verilog 2001 standard if verilog is being used. To run Synthesis, select **Run.**

Place-and-Route in Libero SoC

Having set the design route appropriately and run Synthesis, click **Layout** in the Libero SoC to invoke Designer. CoreSDR_AXI requires no special place-and-route settings.

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SARS Being Resolved

There are no SARS being resolved for CoreSDR_AXI. This is a new core. However, the latest version of CoreSDR is used as a basis, with any relevant SARs being closed for CoreSDR IP.

Any RTL changes made for CoreSDR_AXI must be implemented in CoreSDR in the future release (4.1). Table 3 lists the relevant outstanding SARs for CoreSDR.

Table 3 ·CoreSDR SARs To Be Resolved

SAR	Type	Description
21832	RTL	Signals in fastinit.vhd missing drivers. Need to tie-off, remove, or connect, as required
25196	RTL	VHDL does not match up with the verilog—parameters are not propagated through the core to lower-level components (fastsdram block).

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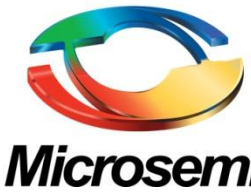

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